## FEATURES

Ultralow standby power IDD $=50$ nA typical

## 256-position

End-to-end resistance 100 k $\Omega$
Logic high voltage 1.8 V
Power supply 2.7 V to 5.5 V
Low temperature coefficient $35 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
Compact thin 8-lead TSOT-8 ( $2.9 \mathrm{~mm} \times 2.8 \mathrm{~mm}$ ) package
Simple 3-wire digital interface
Wide operating temperature $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Pin-to-pin compatible to AD5160 with CS inverted

## APPLICATIONS

Battery-operated electronics adjustment
Remote utilities meter adjustment
Mechanical potentiometer replacement
Transducer circuit adjustment
Automotive electronics adjustment
Gain control and offset adjustment
System calibration
VCXO adjustment

## GENERAL OVERVIEW

The AD5165 provides a compact $2.9 \mathrm{~mm} \times 2.8 \mathrm{~mm}$ packaged solution for 256-position adjustment applications. These devices perform the same electronic adjustment function as mechanical potentiometers or variable resistors, with enhanced resolution, solid-state reliability, and superior low temperature coefficient performance. The AD5165's supply voltage requirement is 2.7 V to 5.5 V , but its logic voltage requirement is 1.8 V to $\mathrm{V}_{\mathrm{DD}}$. The AD5165 consumes very low quiescent power during standby mode and is ideal for battery-operated applications.

Wiper settings are controlled through a simple 3-wire interface. The interface is similar to the SPI ${ }^{\oplus}$ digital interface except for the inverted chip-select function that minimizes logic power consumption in the idling state. The resistance between the wiper and either endpoint of the fixed resistor varies linearly with respect to the digital code transferred into the wiper register.

Operating from a 2.7 V to 5.5 V power supply and consuming less than 50 nA typical standby power allows use in batteryoperated portable or remote utility device applications.

Rev. 0
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FUNCTIONAL BLOCK DIAGRAM


Figure 1.

## PIN CONFIGURATION



Figure 2.

## TYPICAL APPLICATION



Figure 3.

Note:
The terms digital potentiometer, RDAC, and VR are used interchangeably.

[^0]
## AD5165

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## REVISION HISTORY

4/04—Revision 0: Initial Version

## ELECTRICAL CHARACTERISTICS—100 k VERSION

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$, or $3 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}} ; \mathrm{V}_{\mathrm{B}}=0 \mathrm{~V} ;-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$; unless otherwise noted.
Table 1.

| Parameter | Symbol | Conditions | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS—RHEOSTAT MOD <br> Resistor Differential Nonlinearity ${ }^{2}$ <br> Resistor Integral Nonlinearity ${ }^{2}$ <br> Nominal Resistor Tolerance ${ }^{3}$ <br> Resistance Temperature Coefficient <br> Wiper Resistance | R-DNL <br> R-INL <br> $\Delta R_{A B} / R_{A B}$ <br> $\left(\Delta \mathrm{R}_{A B} / \mathrm{R}_{A B}\right) / \Delta \mathrm{Tx} 10^{6}$ <br> Rw | $\begin{aligned} & \text { RwB, } V_{A}=\text { no connect } \\ & R_{W B}, V_{A}=\text { no connect } \\ & T_{A}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{A B}=V_{D D} \text { wiper }=\text { no connect } \\ & V_{D D}=2.7 \mathrm{~V} / 5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -1 \\ & -2 \\ & -20 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \\ & 35 \\ & 85 / 50 \end{aligned}$ | $\begin{aligned} & +1 \\ & +2 \\ & +20 \\ & \\ & 150 / 120 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \% \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \Omega \end{aligned}$ |
| DC CHARACTERISTICS—POTENTIOMETER <br> Resolution <br> Differential Nonlinearity ${ }^{4}$ <br> Integral Nonlinearity ${ }^{4}$ <br> Voltage Divider Temperature <br> Coefficient <br> Full-Scale Error <br> Zero-Scale Error | VIDER MODE <br> N <br> DNL <br> INL <br> $\left(\Delta \mathrm{V}_{\mathrm{w}} / \mathrm{V}_{\mathrm{w}}\right) / \Delta \mathrm{Tx} 10^{6}$ <br> $V_{\text {wfse }}$ <br> V wZSE | $\begin{aligned} & \text { Code }=0 \times 80 \\ & \text { Code }=0 \times F F \\ & \text { Code }=0 \times 00 \end{aligned}$ | $\begin{aligned} & -1 \\ & -1 \\ & -0.5 \\ & 0 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.3 \\ & 15 \\ & -0.3 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 8 \\ & +1 \\ & +1 \\ & \\ & 0 \\ & 0.5 \end{aligned}$ | Bits <br> LSB <br> LSB <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> LSB <br> LSB |
| RESISTOR TERMINALS <br> Voltage Range ${ }^{5}$ <br> Capacitance ${ }^{6}$ A, B <br> Capacitance ${ }^{6}$ W <br> Common-Mode Leakage | $V_{A, B, W}$ $\mathrm{C}_{\mathrm{A}, \mathrm{B}}$ <br> $C_{w}$ <br> Icm | $\mathrm{f}=1 \mathrm{MHz}$, measured to GND, <br> Code $=0 \times 80$ <br> $\mathrm{f}=1 \mathrm{MHz}$, measured to GND, <br> Code $=0 \times 80$ $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{B}}=\mathrm{V}_{\mathrm{DD}} / 2$ | GND | 90 95 1 | $V_{\text {DD }}$ | V pF pF nA |
| DIGITAL INPUTS AND OUTPUTS <br> Input Logic High <br> Input Logic Low Input Capacitance ${ }^{6}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IL}} \\ & \mathrm{C}_{\mathrm{IL}} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=2.7 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \end{aligned}$ | 1.8 | 5 | 0.6 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLIES <br> Power Supply Range Supply Current <br> Power Dissipation ${ }^{7}$ Power Supply Sensitivity | Vddrange IDD <br> PDISS PSS | Digital inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ <br> $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$, digital inputs $=1.8 \mathrm{~V}$ <br> $V_{D D}=5 \mathrm{~V}$, digital inputs $=1.8 \mathrm{~V}$ <br> Digital inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ <br> $V_{D D}=+5 \mathrm{~V} \pm 10 \%$, <br> Code $=$ Midscale | 2.7 | $\begin{aligned} & 0.05 \\ & 10 \\ & 500 \\ & \\ & \pm 0.001 \end{aligned}$ | 5.5 <br> 1 <br> 5.5 $\pm 0.005$ | V $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{W}$ \%/\% |
| DYNAMIC CHARACTERISTICS ${ }^{6,8}$ <br> Bandwidth - 3 dB <br> Total Harmonic Distortion $\mathrm{V}_{\mathrm{w}}$ Settling Time <br> Resistor Noise Voltage Density | BW <br> THD w <br> ts <br> $\mathrm{e}_{\mathrm{N}, \mathrm{wb}}$ | $\begin{aligned} & \text { Code }=0 \times 80 \\ & \mathrm{~V}_{\mathrm{A}}=1 \mathrm{Vrms}, \mathrm{~V}_{\mathrm{B}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \\ & \mathrm{~V}_{\mathrm{A}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}}=0 \mathrm{~V}, \\ & \pm 1 \mathrm{LSB} \text { error band } \\ & \mathrm{R}_{\mathrm{WB}}=50 \mathrm{k} \Omega \end{aligned}$ |  | $\begin{aligned} & 55 \\ & 0.05 \\ & 2 \\ & 28 \\ & \hline \end{aligned}$ |  | kHz <br> \% <br> $\mu \mathrm{s}$ <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |

[^1]
## AD5165

## TIMING CHARACTERISTICS—100 k VERSION

$\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$, or $+3 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}} ; \mathrm{V}_{\mathrm{B}}=0 \mathrm{~V} ;-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$; unless otherwise noted.
Table 2.

| Parameter | Symbol | Conditions | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 3-WIRE INTERFACE TIMING CHARACTERISTICS ${ }^{2,3,4}$ (specifications apply to all parts) |  |  |  |  |  |  |
| Clock Frequency |  |  |  |  | 25 | MHz |
| Input Clock Pulse Width | $\mathrm{tch}, \mathrm{tcl}^{\text {l }}$ | Clock level high or low | 20 |  |  | ns |
| Data Setup Time | tDs |  | 5 |  |  | ns |
| Data Hold Time | $\mathrm{t}_{\text {DH }}$ |  | 5 |  |  | ns |
| CS Setup Time | tcss |  | 15 |  |  | ns |
| CS Low Pulse Width | tcsw |  | 40 |  |  | ns |
| CLK Fall to CS Rise Hold Time | $\mathrm{t}_{\text {cSHO }}$ |  | 0 |  |  | ns |
| CLK Fall to CS Fall Hold Time | tcSH1 |  | 0 |  |  | ns |
| CS Fall to Clock Rise Setup | $\mathrm{t}_{\text {c1 }}$ |  | 10 |  |  | ns |

[^2]
## AD5165

## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. ${ }^{1,2}$
Table 3.

| Parameter | Value |
| :---: | :---: |
| $V_{\text {DD }}$ to GND | -0.3 V to +7 V |
| $V_{A}, V_{B}, V_{w}$ to GND | VDD |
| Maximum Current |  |
| Imb, Ima Pulsed | $\pm 20 \mathrm{~mA}$ |
| $\mathrm{I}_{\text {wB }}$ Continuous ( $\mathrm{R}_{\text {wb }} \leq 1 \mathrm{k} \Omega$, A open) ${ }^{2}$ | $\pm 5 \mathrm{~mA}$ |
| Ima Continuous ( $\mathrm{Rwa}^{\text {}} \leq 1 \mathrm{k} \Omega$, B open) ${ }^{2}$ | $\pm 5 \mathrm{~mA}$ |
| Digital Inputs and Output Voltage to GND | 0 V to +7 V |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature (Tımax) | $150^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10-30 sec) | $245^{\circ} \mathrm{C}$ |
| Thermal Resistance ${ }^{2} \theta_{\text {JA: }}$ : TSOT-8 | $200^{\circ} \mathrm{C} / \mathrm{W}$ |

${ }^{1}$ Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the $\mathrm{A}, \mathrm{B}$, and W terminals at a given resistance.
${ }^{2}$ Package power dissipation $=\left(\mathrm{T}_{\text {JMAX }}-\mathrm{TA}\right) / \theta_{\mathrm{JA}}$.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance

## AD5165

## PIN CONFIGURATION AND FUNCTIONAL DESCRIPTIONS



Table 4.

| Pin | Name | Description |
| :--- | :--- | :--- |
| 1 | W | Wiper terminal. GND $\leq \mathrm{V}_{\mathrm{A}} \leq \mathrm{V}_{\mathrm{DD}}$. |
| 2 | $\mathrm{~V}_{\mathrm{DD}}$ | Positive Power Supply. |
| 3 | GND | Digital Ground. |
| 4 | CLK | Serial Clock Input. Positive-edge triggered. |
| 5 | SDI | Serial Data Input (data loads $M S B$ first). |
| 6 | CS | Chip Select Input, active high. When CS returns low, data is loaded into the wiper register. |
| 7 | B | B terminal. GND $\leq \mathrm{V}_{\mathrm{A}} \leq \mathrm{V}_{\mathrm{DD}}$. |
| 8 | A | A terminal. GND $\leq \mathrm{V}_{\mathrm{A}} \leq \mathrm{V}_{\mathrm{DD}}$. |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 5. R-INL vs. Code vs. Supply Voltages


Figure 6. R-DNL vs. Code vs. Supply Voltages


Figure 7. INL vs. Code vs. Temperature , VDD $=5 \mathrm{~V}$


Figure 8. DNL vs. Code vs. Temperature, VDD $=5 \mathrm{~V}$


Figure 9. INL vs. Code vs. Supply Voltages


Figure 10. DNL vs. Code vs. Supply Voltages


Figure 11. R -INL vs. Code vs. Temperature, $V_{D D}=5 \mathrm{~V}$


Figure 12. $R$-DNL vs. Code vs. Temperature, $V_{D D}=5 \mathrm{~V}$


Figure 13. Full-Scale Error vs. Temperature


Figure 14. Zero-Scale Error vs. Temperature


04749-0.020

Figure 15. Supply Current vs. Temperature


Figure 16. Supply Current vs. Digital Input Voltage


Figure 17. Supply Current vs. Digital Input Voltage


Figure 18. Rheostat Mode Tempco $\Delta R_{w B} / \Delta T$ vs. Code


Figure 19. Potentiometer Mode Tempco $\Delta V_{w B} / \Delta T$ vs. Code


Figure 20. Gain vs. Frequency vs. Code, $R_{A B}=100 \mathrm{k} \Omega$


Figure 21. $-3 d B$ Bandwidth $@$ Code $=0 \times 80$


Figure 22. PSRR vs. Frequency

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Figure 26. Midscale Glitch, Code 0x80-0x7F

Figure 23. IDD vs. Frequency


Figure 24. Large Signal Settling Time, Code 0xFF-0x00


Figure 25. Digital Feedthrough

## TEST CIRCUITS

Figure 27 to Figure 33 illustrate the test circuits that define the test conditions used in the product specification tables.


Figure 27. Test Circuit for Potentiometer Divider Nonlinearity Error (INL, DNL)


Figure 28. Test Circuit for Resistor Position Nonlinearity Error (Rheostat Operation; R-INL, R-DNL)


Figure 29. Test Circuit for Wiper Resistance


Figure 30. Test Circuit for Power Supply Sensitivity (PSS, PSSR)


Figure 31. Test Circuit for Gain vs. Frequency


Figure 32. Test Circuit for Incremental ON Resistance


Figure 33. Test Circuit for Common-Mode Leakage Current

## AD5165

## 3-WIRE DIGITAL INTERFACE

Note that in the AD5165 data is loaded MSB first.
Table 5. AD5165 Serial Data-Word Format

| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| D7 <br> MSB <br> $2^{7}$ | D6 | D5 | D4 | D3 | D2 | D1 | D0 |



Figure 35. 3-Wire Digital Interface Detailed Timing Diagram $\left(V_{A}=5 V, V_{B}=0 V, V_{W}=V_{\text {out }}\right)$

## AD5165

## THEORY OF OPERATION

The AD5165 is a 256-position digitally controlled variable resistor (VR) device.

## PROGRAMMING THE VARIABLE RESISTOR Rheostat Operation

The nominal resistance of the RDAC between terminals A and $B$ is available in $100 \mathrm{k} \Omega$. The nominal resistance $\left(\mathrm{R}_{A B}\right)$ of the VR has 256 contact points accessed by the wiper terminal, plus the B terminal contact. The 8 -bit data in the RDAC latch is decoded to select one of the 256 possible settings.


Figure 36. Rheostat Mode Configuration
Assuming that a $100 \mathrm{k} \Omega$ part is used, the wiper's first connection starts at the $B$ terminal for data $0 \times 00$. Because there is a $50 \Omega$ wiper contact resistance, such a connection yields a minimum of $100 \Omega(2 \times 50 \Omega)$ resistance between terminals W and B. The second connection is the first tap point, which corresponds to $490 \Omega\left(R_{W B}=R_{A B} / 256+2 \times R_{W}=390 \Omega+2 \times 50 \Omega\right)$ for data $0 x 01$. The third connection is the next tap point, representing $880 \Omega(2 \times 390 \Omega+2 \times 50 \Omega)$ for data $0 \times 02$, and so on. Each LSB data value increase moves the wiper up the resistor ladder until the last tap point is reached at $100,100 \Omega$ $\left(R_{A B}+2 \times R_{W}\right)$.


Figure 37. AD5165 Equivalent RDAC Circuit

The general equation determining the digitally programmed output resistance between $W$ and $B$ is

$$
\begin{equation*}
R_{W B}(D)=\frac{D}{256} \times R_{A B}+2 \times R_{W} \tag{1}
\end{equation*}
$$

where:
$D$ is the decimal equivalent of the binary code loaded in the 8 -bit RDAC register.
$R_{A B}$ is the end-to-end resistance.
$R_{W}$ is the wiper resistance contributed by the on resistance of the internal switch.

In summary, if $R_{A B}=100 \mathrm{k} \Omega$ and the $A$ terminal is open circuited, the following output resistance $R_{W B}$ is set for the indicated RDAC latch codes.

Table 6. Codes and Corresponding Rwb Resistance

| D (Dec.) | Rwв $(\mathbf{\Omega})$ | Output State |
| :--- | :--- | :--- |
| 255 | 99,710 | Full scale $\left(R_{A B}-1\right.$ LSB $\left.+R_{w}\right)$ |
| 128 | 50,100 | Midscale |
| 1 | 490 | 1 LSB |
| 0 | 100 | Zero scale (wiper contact resistance) |

Note that, in the zero-scale condition, a finite wiper resistance of $100 \Omega$ is present. Care should be taken to limit the current flow between W and B in this state to a maximum pulse current of no more than 20 mA . Otherwise, degradation or possible destruction of the internal switch contact can occur.

Similar to the mechanical potentiometer, the resistance of the RDAC between the wiper W and terminal A also produces a digitally controlled complementary resistance, $R_{W A}$. When these terminals are used, the B terminal can be opened. Setting the resistance value for $\mathrm{RWA}_{\mathrm{WA}}$ starts at a maximum value of resistance and decreases as the data loaded in the latch increases in value. The general equation for this operation is

$$
\begin{equation*}
R_{W A}(D)=\frac{256-D}{256} \times R_{A B}+2 \times R_{W} \tag{2}
\end{equation*}
$$

For $R_{A B}=100 \mathrm{k} \Omega$ with the $B$ terminal open circuited, the following output resistance $\mathrm{R}_{w A}$ is set for the indicated RDAC latch codes.

Table 7. Codes and Corresponding Rwa $_{\text {wa }}$ Resistance

| D (Dec.) | Rwa $^{(\boldsymbol{\Omega})}$ | Output State |
| :--- | :--- | :--- |
| 255 | 490 | Full scale |
| 128 | 50,100 | Midscale |
| 1 | 99,710 | 1 LSB |
| 0 | 100,100 | Zero scale |

Typical device-to-device matching is process-lot dependent and may vary by up to $\pm 20 \%$. Because the resistance element is processed in thin film technology, the change in $R_{A B}$ with temperature has a very low $35 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ temperature coefficient.

## AD5165

## PROGRAMMING THE POTENTIOMETER DIVIDER Voltage Output Operation

The digital potentiometer easily generates a voltage divider at wiper-to-B and wiper-to-A proportional to the input voltage at $A$ to $B$. Unlike the polarity of $V_{D D}$ to GND, which must be positive, voltage across $A$ to $B, W$ to $A$, and $W$ to $B$ can be at either polarity.


Figure 38. Potentiometer Mode Configuration
If ignoring the effect of the wiper resistance for approximation, connecting the A terminal to 5 V and the B terminal to ground produces an output voltage at the wiper-to- B starting at 0 V up to 1 LSB less than 5 V . Each LSB of voltage is equal to the voltage applied across terminals A and B divided by the 256 positions of the potentiometer divider. The general equation defining the output voltage at $\mathrm{V}_{\mathrm{w}}$ with respect to ground for any valid input voltage applied to terminals $A$ and $B$ is

$$
\begin{equation*}
V_{W}(D)=\frac{D}{256} V_{A}+\frac{256-D}{256} V_{B} \tag{3}
\end{equation*}
$$

A more accurate calculation, which includes the effect of wiper resistance, $V_{W}$, is

$$
\begin{equation*}
V_{W}(D)=\frac{R_{W B}(D)}{R_{A B}} V_{A}+\frac{R_{W A}(D)}{R_{A B}} V_{B} \tag{4}
\end{equation*}
$$

Operation of the digital potentiometer in the divider mode results in a more accurate operation over temperature. Unlike the rheostat mode, the output voltage is dependent mainly on the ratio of the internal resistors $\mathrm{R}_{\mathrm{WA}}$ and $\mathrm{R}_{\mathrm{WB}}$ and not the absolute values. Therefore, the temperature drift reduces to $15 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.

## 3-WIRE SERIAL BUS DIGITAL INTERFACE

The AD5165 contains a 3-wire digital interface (SDI, CS, and CLK). The 8 -bit serial word must be loaded MSB first. The format of the word is shown in Table 5.

The positive-edge sensitive CLK input requires clean transitions to avoid clocking incorrect data into the serial input register. Standard logic families work well. If mechanical switches are used for product evaluation, they should be debounced by a flip-flop or other suitable means. When CS is high, the clock loads data into the serial register on each positive clock edge, as shown in Figure 34.

The data setup and data hold times in the specifications table determine the valid timing requirements. The AD5165 uses an 8 -bit serial input data register word that is transferred to the internal RDAC register when the CS line returns to logic low. Extra MSB bits are ignored.

## ESD PROTECTION

All digital inputs are protected with a series of input resistors and parallel Zener ESD structures, shown in Figure 39 and Figure 40. This applies to the digital input pins SDI, CLK, and CS.


Figure 39. ESD Protection of Digital Pins


Figure 40. ESD Protection of Resistor Terminals

## TERMINAL VOLTAGE OPERATING RANGE

The AD5165 V $\mathrm{V}_{\mathrm{DD}}$ and GND power supply defines the boundary conditions for proper 3-terminal digital potentiometer operation. Supply signals present on terminals A, B, and W that exceed $V_{D D}$ or GND are clamped by the internal forward-biased diodes, as shown in Figure 41.


Figure 41. Maximum Terminal Voltages Set by $V_{D D}$ and GND

## POWER-UP SEQUENCE

Because the ESD protection diodes limit the voltage compliance at terminals A, B, and W (see Figure 41), it is important to power $\mathrm{V}_{\mathrm{DD}} / \mathrm{GND}$ before applying any voltage to terminals $\mathrm{A}, \mathrm{B}$, and W ; otherwise, the diode is forward biased such that $V_{D D}$ is powered unintentionally and may affect the rest of the user's circuit. The ideal power-up sequence is in the following order: GND, $V_{D D}$, digital inputs, and then $V_{A}, V_{B}$, and $V_{w}$. The relative order of powering $\mathrm{V}_{\mathrm{A}}, \mathrm{V}_{\mathrm{B}}, \mathrm{V}_{\mathrm{W}}$, and the digital inputs is not important as long as they are powered after $V_{\mathrm{DD}} / \mathrm{GND}$.

## LAYOUT AND POWER SUPPLY BYPASSING

It is good practice to employ compact, minimum lead length layout design. The leads to the inputs should be as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance.

Similarly, it is also good practice to bypass the power supplies with quality capacitors for optimum stability. Supply leads to the device should be bypassed with disk or chip ceramic capacitors of $0.01 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$. Low ESR $1 \mu \mathrm{~F}$ to $10 \mu \mathrm{~F}$ tantalum or electrolytic capacitors should also be applied at the supplies to minimize any transient disturbance and low frequency ripple (see Figure 42). Note that the digital ground should also be joined remotely to the analog ground at one point to minimize the ground bounce.


Figure 42. Power Supply Bypassing

## EVALUATION BOARD

An evaluation board, along with all necessary software, is available to program the AD5165 from any PC running Windows ${ }^{\bullet} 98 / 2000 / X P$. The graphical user interface, as shown in Figure 43, is straightforward and easy to use. More detailed information is available in the user manual, which comes with the board.


Figure 43. AD5165 Evaluation Board Software
The AD5165 starts at midscale upon power-up. To increment or decrement the resistance, the user may move the scroll bars on the left. To write any specific value, the user should use the bit pattern in the upper screen and click the Run button. The format of writing data to the device is shown in Figure 32.

## AD5165

## OUTLINE DIMENSIONS



Figure 44. 8-Lead Thin Small Outline Transistor Package [Thin SOT-23] (UJ-8)
Dimensions shown in millimeters

ORDERING GUIDE

| Model | RAB $^{(\Omega)} \mathbf{\Omega}$ | Temperature | Package Description | Package Option | Quantity on Reel | Branding |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| AD5165BUJZ100-R2 | 100 k | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Thin SOT-23 | UJ-8 | 250 | D3N |
| AD5165BUJZ100-R7 ${ }^{1}$ | 100 k | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Thin SOT-23 | UJ-8 | 3,000 | D3N |
| AD5165EVAL |  |  | Evaluation Board |  |  |  |

${ }^{1} Z=P b$-free part.

## X-ON Electronics

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9316401MXA 5962-9452101M2A EV1HMC1160LP5 EV1HMC305SLP4 EV1HMC306AMS10 EV1HMC557ALC4 EV1HMC6146BLC5A
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ADF70301-868BZ EV-ADUCM322IQSPZ EV-ADUCM322QSPZ EVAL01-HMC1048LC3B EVAL01-HMC1055LP2C EVAL01-
HMC1063LP3 EVAL01-HMC197B EVAL01-HMC760LC4B EVAL01-HMC829LP6GE EVAL01-HMC833LP6GE EVAL01-
HMC835LP6G EVAL01-HMC985LP4KE EVAL01-HMC987LP5E EVAL01-HMC988LP3E EVAL01-HMC995LP5GE EVAL02-
HMC1034LP6G EVAL-3CH4CHSOICEBZ EVAL-AD1871EBZ EVAL-AD5063EBZ EVAL-AD5064EBZ EVAL-AD5171DBZ


[^0]:    One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 www.analog.com Fax: 781.326.8703 © 2004 Analog Devices, Inc. All rights reserved.

[^1]:    ${ }^{1}$ Typical specifications represent average readings at $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.
    ${ }^{2}$ Resistor position nonlinearity error R-INL is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. Parts are guaranteed monotonic.
    ${ }^{3} \mathrm{~V}_{\mathrm{AB}}=\mathrm{V}_{\mathrm{DD}}$, wiper $\left(\mathrm{V}_{\mathrm{w}}\right)=$ no connect.
    ${ }^{4} I N L$ and DNL are measured at $\mathrm{V}_{\mathrm{W}}$ with the RDAC configured as a potentiometer divider similar to a voltage output $\mathrm{D} / \mathrm{A}$ converter. $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{B}}=0 \mathrm{~V}$.
    ${ }^{5}$ Resistor terminals A, B, and W have no limitations on polarity with respect to each other.
    ${ }^{6}$ Guaranteed by design and not subject to production test.
    ${ }^{7} \mathrm{P}_{\text {DISS }}$ is calculated from ( $\mathrm{l}_{\mathrm{DD}} \times \mathrm{V}_{\mathrm{DD}}$ ). CMOS logic level inputs result in minimum power dissipation.
    ${ }^{8}$ All dynamic characteristics use $V_{D D}=5 \mathrm{~V}$.

[^2]:    ${ }^{1}$ Typical specifications represent average readings at $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.
    ${ }^{2}$ Guaranteed by design and not subject to production test.
    ${ }^{3}$ All dynamic characteristics use $V_{D D}=5 \mathrm{~V}$.
    ${ }^{4}$ See Figure 34 and Figure 35 for location of measured values. All input control voltages are specified with $t_{R}=t_{F}=2 \mathrm{~ns}(10 \%$ to $90 \%$ of 3 V ) and timed from a voltage level of 1.5 V .

